



## Description

The NTMFS5C426NT3G use advanced SGT MOSFET technology to provide low  $R_{DS(ON)}$ , low gate charge, fast switching and excellent avalanche characteristics. This device is specially designed to get better ruggedness and suitable.

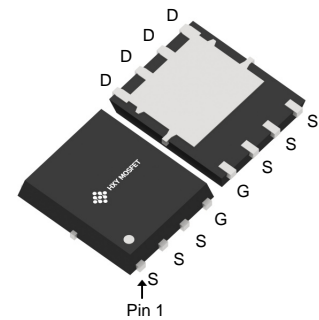
## General Features

$V_{DS} = 40V$   $I_D = 219A$

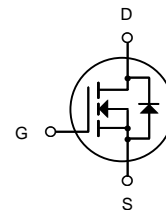
$R_{DS(ON)} < 1.5m\Omega$   $V_{GS}=10V$

## Applications

Consumer electronic power supply Motor control  
Synchronous-rectification Isolated DC  
Synchronous-rectification applications



DFN5X6-8L



N-Channel MOSFET

## Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
NTMFS5C426NT3G	DFN5X6-8L	HXY MOSFET	5000

## Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	40	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D@T_C=25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^1$	219	A
$I_D@T_C=100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^1$	138	A
$I_{DM}$	Pulsed Drain Current <sup>4</sup>	345	A
EAS	Single Pulse Avalanche Energy <sup>5</sup>	69	mJ
$P_D@T_C=25^\circ C$	Total Power Dissipation	114	W
$T_{STG}$	Storage Temperature Range	-50 to 150	°C
$T_J$	Operating Junction Temperature Range	-50 to 150	°C
$R_{\theta JA}$	Thermal Resistance Junction-Ambient <sup>3</sup>	43.2	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-Case	1.1	°C/W



**Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)**

Symbol	Parameter	Conditions	Min.	Typ.	Max	Unit
<b>Static Characteristics</b>						
BV <sub>DSS</sub>	Drain Source breakdown voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA, T <sub>J</sub> =25°C	40	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V	-	-	1	uA
I <sub>GSS</sub>	Gate-to-Source Forward Leakage	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	1.4	-	2.3	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	1.2	1.5	mΩ
		V <sub>GS</sub> =5V, I <sub>D</sub> =20A	-	1.7	2.2	mΩ
R <sub>G</sub>	Gate Resistance	f = 1 MHz	-	1.5	-	Ω
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0V V <sub>DS</sub> = 20V f = 150KHz	-	6461	-	pF
C <sub>oss</sub>	Output Capacitance		-	3257	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	196	-	pF
<b>Switching Characteristics</b>						
T <sub>D(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> = 20V V <sub>GS</sub> = 4.5V R <sub>G</sub> = 3Ω I <sub>D</sub> = 20A	-	24	-	ns
T <sub>r</sub>	Turn-on Rise Time		-	84	-	ns
T <sub>D(off)</sub>	Turn-off Delay Time		-	62	-	ns
T <sub>f</sub>	Turn-off Fall Time		-	20	-	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>DD</sub> = 20V V <sub>GS</sub> = 4.5V I <sub>D</sub> = 20A	-	55	-	nC
Q <sub>gs</sub>	Gate Source Charge		-	15	-	nC
Q <sub>gd</sub>	Gate Drain Charge		-	19	-	nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	I <sub>S</sub> = 50A, V <sub>GS</sub> = 0V	-	0.8	1.2	V
T <sub>rr</sub>	Reverse Recovery Time	I <sub>S</sub> = 20A, V <sub>GS</sub> = 0V di/dt = 100A/μs	-	171	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	381	-	nC

**Notes:**

1. Rated according to R<sub>θJC</sub>
2. Rated according to R<sub>θJA</sub>
3. Surface mounted on 1 inch<sup>2</sup> FR4 board, 2 oz Cu
4. Limited by maximum T<sub>J</sub>
5. Starting T<sub>J</sub> = 25°C, V<sub>DD</sub> = 30V, V<sub>GS</sub> = 10V, L = 0.5mH
6. Pulse width limited by maximum T<sub>J</sub>



### Typical Characteristics

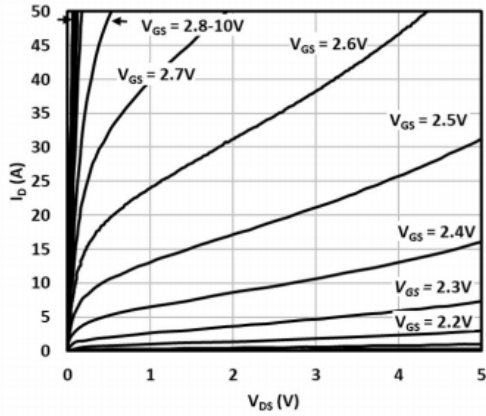


Fig. 1 Output characteristics

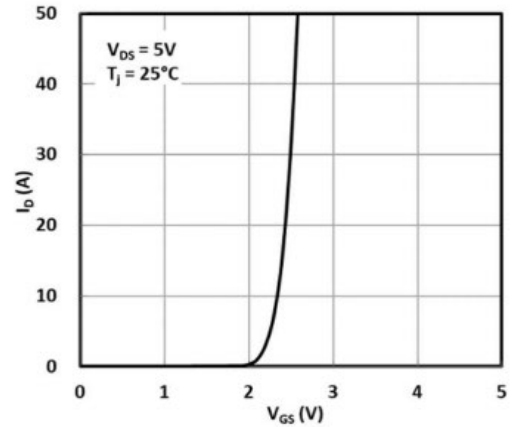


Fig. 2 Transfer characteristics

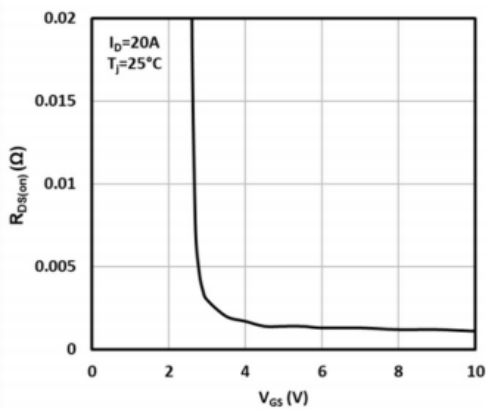


Fig.3 On-resistance vs. gate voltage

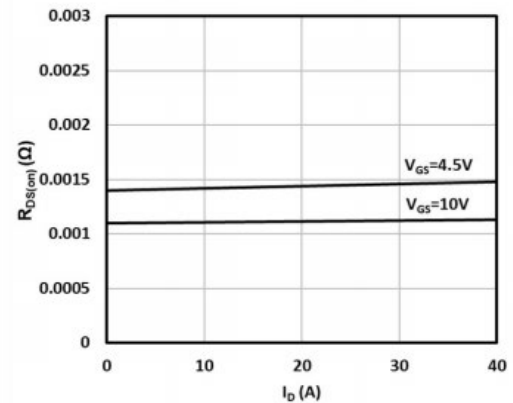


Fig.4 On-resistance vs. drain current

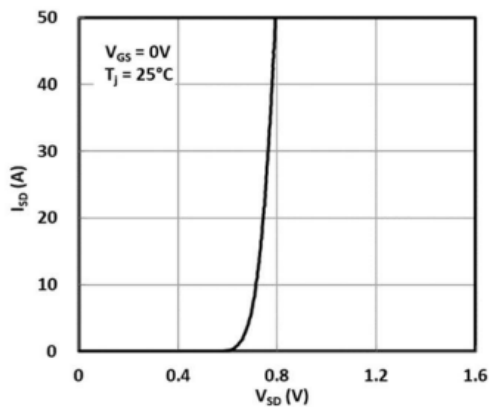


Fig.5 Source-to-drain diode forward characteristics

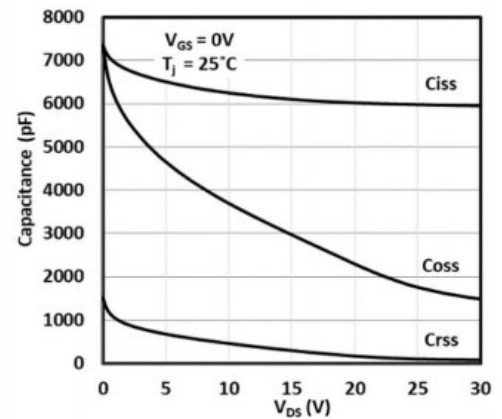


Fig.6 Capacitance vs. drain-to-source voltage

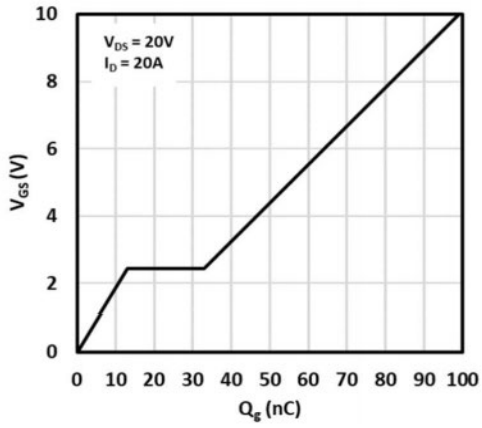


Fig.7 Gate-to-source voltage vs. gate charge

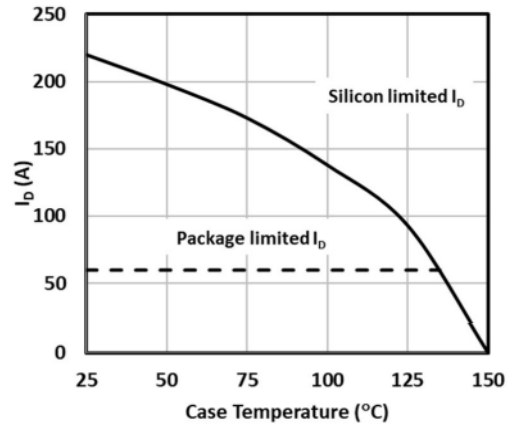


Fig.8 Maximum drain current vs. case temperature

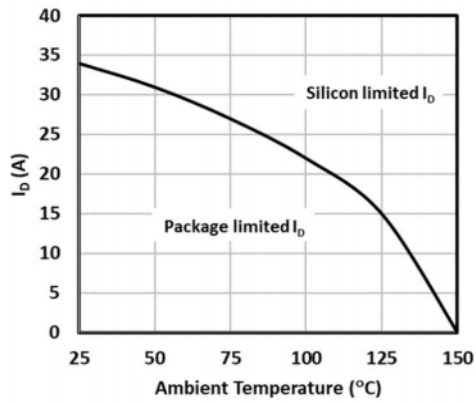
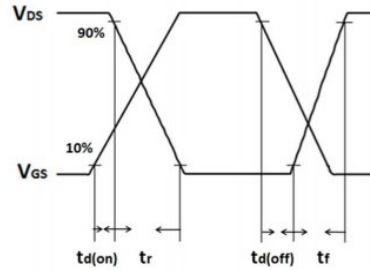
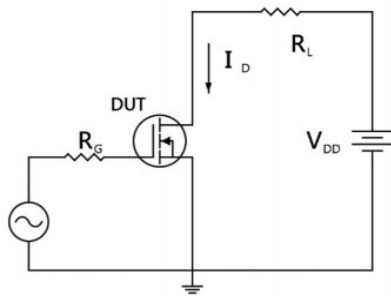


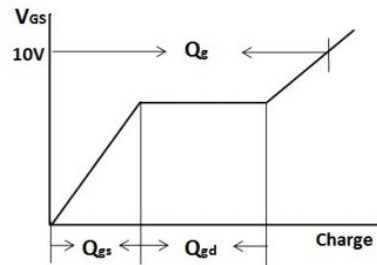
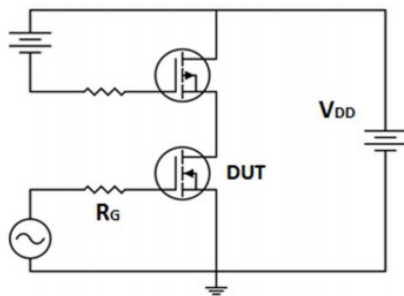
Fig. 9 Maximum drain current vs. ambient temperature



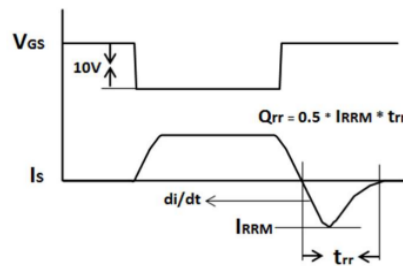
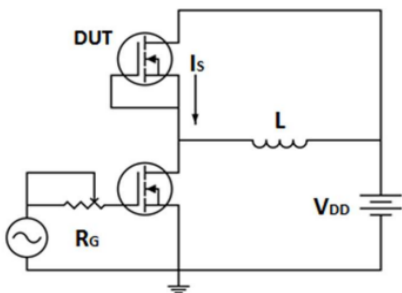
### Test Circuits and Waveforms



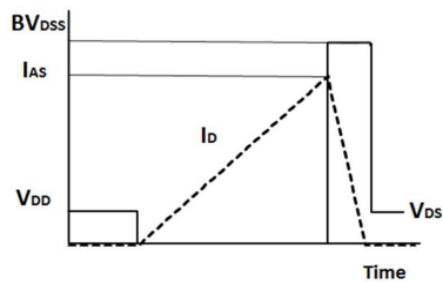
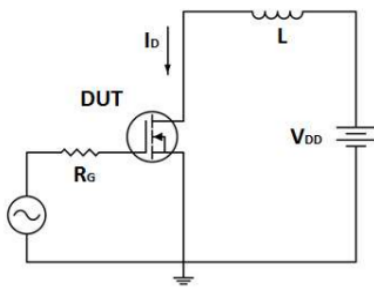
Resistive switching time test circuit & waveforms



Gate charge test circuit & waveform



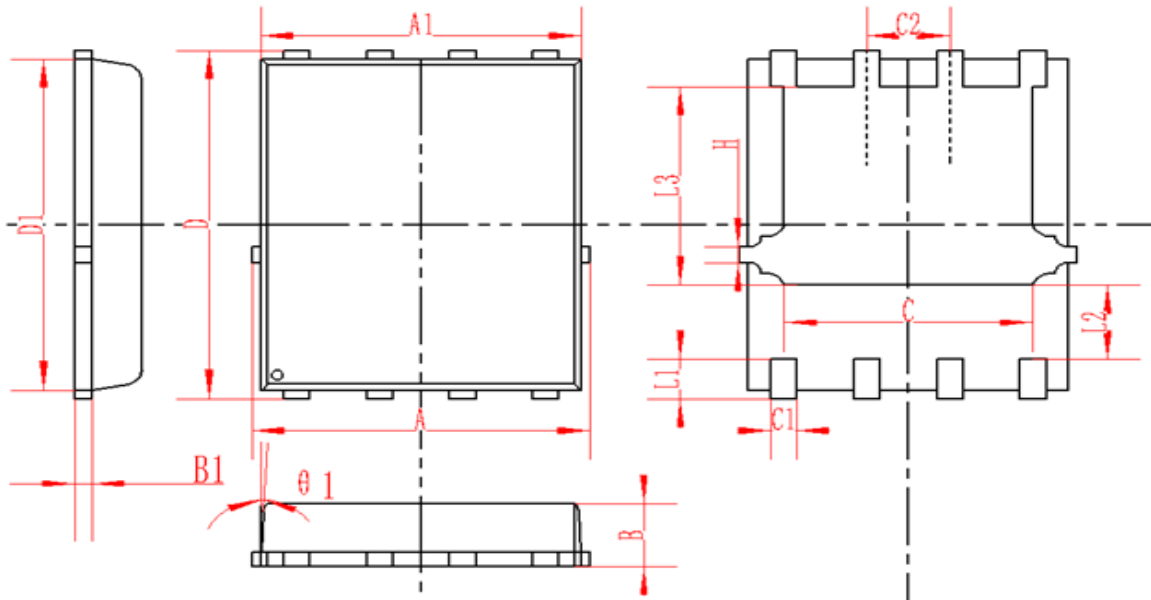
Peak diode recovery dv/dt test circuit & waveforms



Unclamped inductive switching test circuit & waveforms



### DFN5X6-8L Package Information



SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
B	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF			0.010REF		
C	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2	1.27TYP			0.5TYP		
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
H	0.24	0.25	0.26	0.009	0.010	0.010



### Attention

- Any and all HUA XUAN YANG ELECTRONICS products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your HUA XUAN YANG ELECTRONICS representative nearest you before using any HUA XUAN YANG ELECTRONICS products described or contained herein in such applications.
- HUA XUAN YANG ELECTRONICS assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all HUA XUAN YANG ELECTRONICS products described or contained herein.
- Specifications of any and all HUA XUAN YANG ELECTRONICS products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- HUA XUAN YANG ELECTRONICS CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all HUA XUAN YANG ELECTRONICS products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of HUA XUAN YANG ELECTRONICS CO.,LTD.
- Information (including circuit diagrams and circuit parameters) herein is for example only ; it is not guaranteed for volume production. HUA XUAN YANG ELECTRONICS believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the HUA XUAN YANG ELECTRONICS product that you intend to use.